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### **General Description**

The MAX9376 is a fully differential, high-speed, LVDS/anything-to-LVPECL/LVDS dual translator designed for signal rates up to 2GHz. One channel is LVDS/anything-to-LVPECL translator and the other channel is LVDS/anything-to-LVDS translator. The MAX9376's extremely low propagation delay and high speed make it ideal for various high-speed network routing and backplane applications.

The MAX9376 accepts any differential input signal within the supply rails and with minimum amplitude of 100mV. Inputs are fully compatible with the LVDS, LVPECL, HSTL, and CML differential signaling standards. LVPECL outputs have sufficient current to drive  $50\Omega$  transmission lines. LVDS outputs conform to the ANSI EIA/TIA-644 LVDS standard.

The MAX9376 is available in a 10-pin µMAX® package and operates from a single +3.3V supply over the -40°C to +85°C temperature range.

### **Applications**

Backplane Logic Standard Translation

LVDS-to-LVPECL, LVPECL-to-LVDS Up/Downconverters

LANs

**WANs** 

**DSLAMs** 

**DLCs** 

### **Features**

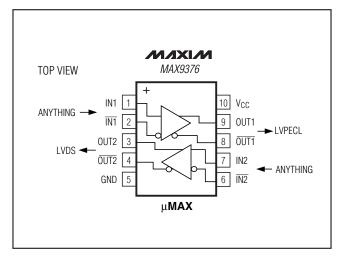
- ♦ Guaranteed 2GHz Switching Frequency
- ♦ Accepts LVDS/LVPECL/Anything Inputs
- ♦ 421ps (typ) Propagation Delays
- ♦ 30ps (max) Pulse Skew
- ♦ 2ps<sub>RMS</sub> (max) Random Jitter
- ♦ Minimum 100mV Differential Input to Guarantee **AC Specifications**
- **♦ Temperature-Compensated LVPECL Output**
- ♦ +3.0V to +3.6V Power-Supply Operating Range
- ♦ >2kV ESD Protection (Human Body Model)

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE		
MAX9376EUB+	-40°C to +85°C	10 μMAX		

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

### **Pin Configuration**



Functional Diagram appears at end of data sheet.

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### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND	0.3V to +4.1V
Inputs (IN_, IN_)	0.3V to (V <sub>CC</sub> + 0.3V)
IN to IN	±3.0V
Continuous Output Current	50mA
Surge Output Current	100mA
Continuous Power Dissipation ( $T_A = +70$	O°C)
10-Pin µMAX (derate 5.6mW/°C abov	ve +70°C)444mW

θ <sub>JA</sub> in Still Air (Note 1)	+180°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
ESD Protection	
Human Body Model (IN_, IN_, OUT_,	
Soldering Temperature (10s)	+300°C

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.maxim-ic.com/thermal-tutorial">www.maxim-ic.com/thermal-tutorial</a>.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC}=+3.0V\text{ to }+3.6V,\text{ differential input voltage }|V_{ID}|=0.1V\text{ to }3.0V,\text{ input voltage }(V_{IN},V_{\overline{IN}})=0\text{ to }V_{CC},\text{ input common-mode voltage }V_{CM}=0.05V\text{ to }(V_{CC}-0.05V),\text{ LVPECL outputs terminated with }50\Omega\pm1\%\text{ to }(V_{CC}-2.0V),\text{ LVDS outputs terminated with }100\Omega\pm1\%,$   $T_{A}=-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . Typical values are at  $V_{CC}=+3.3V,$   $|V_{ID}|=0.2V,$  input common-mode voltage  $V_{CM}=1.2V,$   $T_{A}=+25^{\circ}\text{C},$  unless otherwise noted.) (Notes 2, 3, 4)

DADAMETED	OVMDOL	CONDITIONS		-40°C			+25°C			+85°C		UNITS
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
DIFFERENTIAL INPUTS (IN	I_, ĪN_ )		•									
Differential Input Threshold	V <sub>THD</sub>		-100		+100	-100		+100	-100		+100	mV
Input Current	I <sub>IN</sub> , I <u>IN</u>	$V_{IN}$ , $V_{\overline{IN}} = V_{CC}$ or $0V$	-20		+20	-20		+20	-20		+20	μΑ
Input Common-Mode Voltage	V <sub>CM</sub>	Figure 1	0.05		V <sub>C</sub> C - 0.05	0.05		V <sub>CC</sub> - 0.05	0.05		V <sub>CC</sub> - 0.05	V
LVPECL OUTPUTS (OUT1,	OUT1)		•			,			,			
Single-Ended Output High Voltage	VoH	Figure 3		V <sub>CC</sub> -	V <sub>CC</sub> - 0.880					V <sub>CC</sub> - 0.976		V
Single-Ended Output Low Voltage	V <sub>OL</sub>	Figure 3		V <sub>CC</sub> - 1.745	V <sub>CC</sub> - 1.620					V <sub>CC</sub> - 1.681		V
Differential Output Voltage	VoH - VoL	Figure 3	595	710		595	710		595	710		mV
LVDS OUTPUTS (OUT2, OI	JT2 )		•									
Differential Output Voltage	V <sub>OD</sub>	Figure 2	250	366	450	250	352	450	250	339	450	mV
Change in Magnitude of VOD Between Complementary Output States	IΔV <sub>OD</sub> I	Figure 2		1.0	20		1.0	20		1.0	20	mV
Offset Common-Mode Voltage	Vos	Figure 2	1.125		1.375	1.125	1.250	1.375	1.125		1.375	V
Change in Magnitude of VOS Between Complementary Output States	IΔV <sub>OS</sub> I	Figure 2		1.0	20		1.0	20		1.0	20	mV
Output Short-Circuit Current, Either Output Shorted to GND	llosl	V <sub>ID</sub> = ±100mV, one output GND, other output open or shorted to GND		19	24		18	24		18	24	mA

### DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC}=+3.0V\ to\ +3.6V,\ differential\ input\ voltage\ IV_{ID}I=0.1V\ to\ 3.0V,\ input\ voltage\ (V_{IN},\ V_{\overline{IN}})=0\ to\ V_{CC},\ input\ common-mode\ voltage\ V_{CM}=0.05V\ to\ (V_{CC}-0.05V),\ LVPECL\ outputs\ terminated\ with\ 50\Omega\ \pm1\%\ to\ (V_{CC}-2.0V),\ LVDS\ outputs\ terminated\ with\ 100\Omega\ \pm1\%,\ T_A=-40^{\circ}C\ to\ +85^{\circ}C.\ Typical\ values\ are\ at\ V_{CC}=+3.3V,\ |V_{ID}I=0.2V,\ input\ common-mode\ voltage\ V_{CM}=1.2V,\ T_A=+25^{\circ}C,\ unless\ otherwise\ noted.)$  (Notes 2, 3, 4)

PARAMETER	SYMBOL	CONDITIONS	-40°C			+25°C			+85°C			UNITS
PARAMETER	STINIBUL	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
Output Short-circuit Current, Outputs Shorted Together	II <sub>OSAB</sub> I	$V_{ID} = \pm 100 \text{mV},$ $V_{OUT} + = V_{OUT} -$		4.0	12		4.0	12		4.0	12	mA
SUPPLY												
Supply Current	Icc	All pins open except V <sub>CC</sub> and GND with LVDS outputs (OUT2, OUT2) loaded with differential 100Ω		24	40		29	40		31	40	mA

### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, \text{ differential input voltage } |V_{ID}| = 0.1 \text{V to } 1.2 \text{V}, \text{ input frequency} \le 1.34 \text{GHz}, \text{ differential input transition time} = 125 \text{ps} (20\% \text{ to } 80\%), \text{ input voltage } (V_{IN}, V_{\overline{IN}}) = 0 \text{ to } V_{CC}, \text{ input common-mode voltage } (V_{CM}) = 0.05 \text{V to } (V_{CC} - 0.05 \text{V}), \text{ LVPECL outputs terminated with } 50\Omega \pm 1\% \text{ to } (V_{CC} - 2.0 \text{V}), \text{ LVDS outputs terminated with } 100\Omega \pm 1\%, \text{ } T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3 \text{V}, \text{ } |V_{ID}| = 0.2 \text{V}, \text{ input common-mode voltage } V_{CM} = 1.2 \text{V}, \text{ } T_A = +25 ^{\circ}\text{C}, \text{ unless otherwise noted.}) \text{ (Note 5)}$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LVPECL OUTPUTS						
Switching Frequency	f <sub>MAX</sub>	V <sub>OH</sub> - V <sub>OL</sub> ≥ 250mV	2.0	2.5		GHz
Propagation Delay Low to High	tplh	Figure 3	250	421	600	ps
Propagation Delay High to Low	tphL	Figure 3	250	421	600	ps
Pulse Skew ItpLH - tpHLI	tskew	Figure 3 (Note 6)		6	30	ps
Output Low-to-High Transition	t <sub>R</sub>	Figure 3		116	220	ps
Output High-to-Low Transition	tF	Figure 3		119	220	ps
Added Random Jitter	t <sub>RJ</sub>	f <sub>IN</sub> = 1.34GHz (Note 7)		0.7	2	ps(RMS)
LVDS OUTPUTS						
Switching Frequency	f <sub>MAX</sub>	V <sub>OD</sub> ≥ 250mV	2.0	2.5		GHz
Propagation Delay Low to High	tplh	Figure 3	250	363	600	ps
Propagation Delay High to Low	tphL	Figure 3	250	367	600	ps
Pulse Skew ItpLH - tpHLI	tskew	Figure 3 (Note 6)		5	30	ps
Output Low-to-High Transition Time (20% to 80%)	tR	Figure 2		93	220	ps
Output High-to-Low Transition Time (20% to 80%)	tF	Figure 2		91	220	ps

### **AC ELECTRICAL CHARACTERISTICS (continued)**

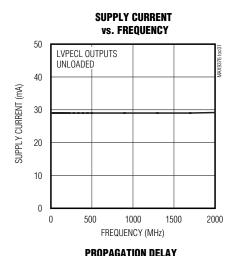
 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, \text{ differential input voltage } |V_{ID}| = 0.1 \text{V to } 1.2 \text{V}, \text{ input frequency} \le 1.34 \text{GHz}, \text{ differential input transition time} = 125 \text{ps} (20\% \text{ to } 80\%), \text{ input voltage } (V_{IN}, V_{\overline{IN}}) = 0 \text{ to } V_{CC}, \text{ input common-mode voltage } (V_{CM}) = 0.05 \text{V to } (V_{CC} - 0.05 \text{V}), \text{ LVPECL outputs terminated with } 50\Omega \pm 1\% \text{ to } (V_{CC} - 2.0 \text{V}), \text{ LVDS outputs terminated with } 100\Omega \pm 1\%, T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3 \text{V}, |V_{ID}| = 0.2 \text{V}, \text{ input common-mode voltage } V_{CM} = 1.2 \text{V}, T_{A} = +25^{\circ}\text{C}, \text{ unless otherwise noted.)} \text{ (Note 5)}$ 

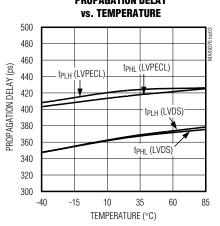
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Added Random Jitter	t <sub>RJ</sub>	f <sub>IN</sub> = 1.34GHz (Note 7)		0.8	2	ps(RMS)

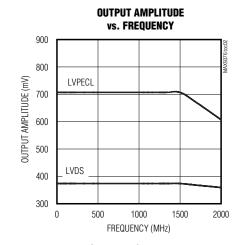
- Note 2: Measurements are made with the device in thermal equilibrium. All voltages are referenced to ground except V<sub>THD</sub>, V<sub>ID</sub>, V<sub>OD</sub>, and ΔV<sub>OD</sub>.
- Note 3: Current into a pin is defined as positive. Current out of a pin is defined as negative.
- **Note 4:** DC parameters production tested at T<sub>A</sub> = +25°C and guaranteed by design and characterization over the full operating temperature range.
- Note 5: Guaranteed by design and characterization, not production tested. Limits are set at ±6 sigma.
- Note 6: tskew is the magnitude difference of differential propagation delays for the same output under same conditions; tskew = ltpHL tpLHl.
- Note 7: Device jitter added to the input signal.

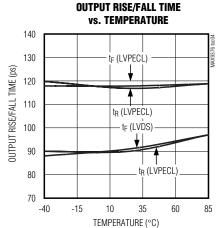
### **Typical Operating Characteristics**

 $(V_{CC} = +3.3V, differential input voltage |V_{ID}| = 0.2V, V_{CM} = 1.2V, input frequency = 500MHz, LVPECL outputs terminated with <math>50\Omega \pm 1\%$  to  $V_{CC}$  - 2.0V, LVDS outputs terminated with  $100\Omega \pm 1\%$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)









### **Pin Description**

PIN	NAME	FUNCTION
1	IN1	Differential LVDS/Anything Noninverting Input 1
2	ĪN1	Differential LVDS/Anything Inverting Input 1
3	OUT2	Differential LVDS Noninverting Output 2. Terminate with $100\Omega \pm 1\%$ to $\overline{OUT2}$ .
4	OUT2	Differential LVDS Inverting Output 2. Terminate with $100\Omega \pm 1\%$ to OUT2.
5	GND	Ground
6	ĪN2	Differential LVDS/Anything Inverting Input 2
7	IN2	Differential LVDS/Anything Noninverting Input 2
8	OUT1	Differential LVPECL Inverting Output. Terminate with 50 $\Omega$ ±1% to V <sub>CC</sub> - 2V.
9	OUT1	Differential LVPECL Noninverting Output. Terminate with $50\Omega \pm 1\%$ to $V_{CC}$ - $2V$ .
10	V <sub>CC</sub>	Positive Supply. Bypass from $V_{CC}$ to GND with $0.1\mu F$ and $0.01\mu F$ ceramic capacitors. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device.

### Detailed Description

The MAX9376 is a fully differential, high-speed, LVDS/anything-to-LVPECL/LVDS dual translator designed for signal rates up to 2GHz. One channel is LVDS/anything-to-LVPECL translator and the other channel is LVDS/anything-to-LVDS translator. The MAX9376's extremely low propagation delay and high speed make it ideal for various high-speed network routing and backplane applications.

The MAX9376 accepts any differential input signal within the supply rails and with a minimum amplitude of 100mV. Inputs are fully compatible with the LVDS, LVPECL, HSTL, and CML differential signaling standards. LVPECL outputs have sufficient current to drive  $50\Omega$  transmission lines. LVDS outputs conform to the ANSI EIA/TIA-644 LVDS standard.

### **Inputs**

Inputs have a wide common-mode range of 0.05V to VCC - 0.05V, which accommodates any differential signals within rails, and requires a minimum of 100mV to

switch the outputs. This allows the MAX9376 inputs to support virtually any differential signaling standard.

### **LVPECL Outputs**

The MAX9376 LVPECL outputs are emitter followers that require external resistive paths to a voltage source (V<sub>T</sub> = V<sub>CC</sub> - 2.0V typ) more negative than worst-case V<sub>OL</sub> for proper static and dynamic operation. When properly terminated, the outputs generate steady-state voltage levels, V<sub>OL</sub> or V<sub>OH</sub> with fast transition edges between state levels. Output current always flows into the termination during proper operation.

### **LVDS Outputs**

The MAX9376 LVDS outputs require a resistive load to terminate the signal and complete the transmission loop. Because the device switches current and not voltage, the actual output voltage swing is determined by the value of the termination resistor. With a 3.5mA typical output current, the MAX9376 produces an output voltage of 350mV when driving a  $100\Omega$  load.

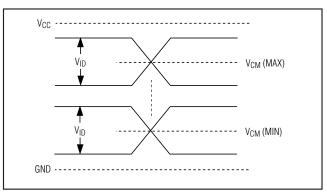


Figure 1. Input Definition

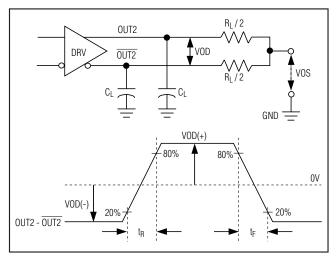


Figure 2. LVDS Output Load and Transition Times

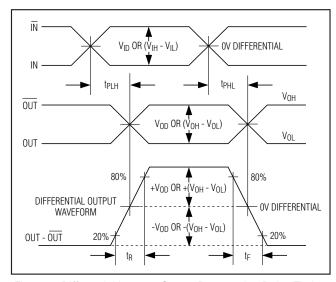


Figure 3. Differential Input-to-Output Propagation Delay Timing Diagram

# Applications Information LVPECL Output Termination

Terminate the MAX9376 LVPECL outputs with  $50\Omega$  to (V<sub>CC</sub> - 2V) or use equivalent Thevenin terminations. Terminate OUT1 and  $\overline{\text{OUT1}}$  with identical termination on each for low output distortion. When a single-ended signal is taken from the differential output, terminate both OUT1 and  $\overline{\text{OUT1}}$ .

Ensure that output currents do not exceed the current limits as specified in the *Absolute Maximum Ratings*. Under all operating conditions, the device's total thermal limits should be observed.

### **LVDS Output Termination**

The MAX9376 LVDS outputs are current-steering devices; no output voltage is generated without a termination resistor. The termination resistors should match the differential impedance of the transmission line. Output voltage levels are dependent upon the value of the termination resistor. The MAX9376 is optimized for point-to-point interface with  $100\Omega$  termination resistors at the receiver inputs. Termination resistance values may range between  $90\Omega$  and  $132\Omega$ , depending on the characteristic impedance of the transmission medium.

### **Supply Bypassing**

Bypass V<sub>CC</sub> to ground with high-frequency surface-mount ceramic  $0.1\mu F$  and  $0.01\mu F$  capacitors. Place the capacitors as close to the device as possible with the  $0.01\mu F$  capacitor closest to the device pins.

### Traces

Circuit board trace layout is very important to maintain the signal integrity of high-speed differential signals. Maintaining integrity is accomplished in part by reducing signal reflections and skew, and increasing common-mode noise immunity.

Signal reflections are caused by discontinuities in the  $50\Omega$  characteristic impedance of the traces. Avoid discontinuities by maintaining the distance between differential traces, not using sharp corners or using vias. Maintaining distance between the traces also increases common-mode noise immunity. Reducing signal skew is accomplished by matching the electrical length of the differential traces.

\_\_ /N/XI/N

# MAX9376

# LVDS/Anything-to-LVPECL/LVDS Dual Translator

\_\_\_\_\_Chip Information

\_\_\_\_\_Package Information

PROCESS: Bipolar

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
10µMAX	U10+2	21-0061

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/03	Initial release	_
1	10/09	Updated Ordering Information and Absolute Maximum Ratings	1, 2

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